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PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

March 21, 2007
Date

Beverly A. Loken
Beverly A. Loken

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant	: Jason B. Elledge	Attorney Docket No.:	500188.02
Patent No.	: US 6,929,530 B1	Serial No.	: 09/616,794
Issue Date	: August 16, 2005	Filed	: July 14, 2000
Title	: APPARATUS FOR IN-SITU OPTICAL ENDPOINTING ON WEB-FORMAT PLANARIZING MACHINES IN MECHANICAL OR CHEMICAL-MECHANICAL PLANARIZATION OF MICROELECTRONIC-DEVICE SUBSTRATE ASSEMBLIES AND METHODS FOR MAKING AND USING SAME		

REQUEST FOR CERTIFICATE OF CORRECTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Certificate
MAR 29 2007
of Correction

Sir:

A Certificate of Correction under 35 U.S.C. § 254 is respectfully requested for the above-identified patent in order to correct Patent and Trademark Office errors made during the printing of the patent or in the original application. The changes in the patent needed to correct the errors are as follows:

<u>Column, Line</u>	<u>Reads</u>	<u>Should Read</u>
Column 5, Line 4	"interferrometer"	--interferometer--

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MAR 1 - 2007

Column 7, Line 32	“system in defined”	--system is defined--
Column 8, Line 28	“substrate assembly the second view site”	--substrate assembly, the second view site--
Column 8, Line 43	“claim 1 wherein the”	--claim 1 wherein--
Column 9, Line 5	“planarizing medium—”	--planarizing medium--
Column 9, Line 13	“located at first area”	--located at a first area--
Column 9, Line 27	“substrate assembly the second view”	--substrate assembly, the second view--
Column 9, Line 32	“the-planarizing medium”	--the planarizing medium--
Column 10, Lines 22-23	“with the first elongated slot through the planarizing medium.”	--with the first elongated slot.--
Column 10, Line 61	“substrate assembly the second view”	--substrate assembly, the second view--
Column 10, Line 66	“and a under surface,”	--and an under surface,--
Column 11, Line 44	“plurality of opening.”	--plurality of openings.--

The above errors for which correction is requested under 35 U.S.C. § 254 were made in the printing of the patent or in the original application. The errors are considered sufficiently important to justify the processing of a Certificate of Correction under 35 U.S.C. § 254. A Form PTO-1050, in duplicate, is enclosed herewith.

The Commissioner is hereby authorized to charge payment of any fees associated with this communication to Deposit Account No. 50-1266. A duplicate copy of this sheet is enclosed.

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Favorable consideration of this Request is respectfully requested.

Respectfully submitted,

Date: March 20, 2007

By: Edward W. Bulchis

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Enclosures:

Postcard

Form PTO-1050 (+ copy)

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**UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION**

PATENT NO. : US 6,929,530 B1
DATED : August 16, 2005
INVENTOR(S) : Jason B. Elledge

It is certified that errors appear in the above identified patent and that said Letters Patent is hereby corrected as shown below:

<u>Column, Line</u>	<u>Reads</u>	<u>Should Read</u>
Column 5, Line 4	"interferrometer"	--interferometer--
Column 7, Line 32	"system in defined"	--system is defined--
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Column 10, Line 66	"and a under surface,"	--and an under surface,--
Column 11, Line 44	"plurality of opening."	--plurality of openings.--

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Patent No. US 6,929,530 B1

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